

11-07-2005

R SHEET



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To the Honorable Assistant Secretary and C

1. Name of conveying party(ies):

Kazuma SEKIYA and Takashi ONO

Additional name(s) of conveying party(ies) attached? NO

3. Nature of conveyance:

- Assignment Merger
- Security Agreement Change of Name
- Other

Execution Date: October 24, 2005

2. Name and address of receiving party(ies):

Name: Disco Corporation

Street Address: 13-11, Omori-Kita 2-chome, Ota-ku, Tokyo,
143-8580 Japan

Additional name(s) & address(es) attached? NO

13255 U.S. PTO
11/262770



4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: October 24, 2006

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached? NO

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: WENDEROTH, LIND & PONACK, L.L.P.
Attn: Charles R. Watts, Esq.

Street Address: 2033 K Street, N.W., Suite 800

City: Washington, State: DC ZIP: 20006-1021

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41). \$40.00

Enclosed (Check No. 70943)
Authorized to be charged to deposit account

8. Deposit account number: 23-0975

(Attach duplicate copy of this page if paying by deposit account)

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Charles R. Watts, Reg. No.33,142
Name of Person Signing

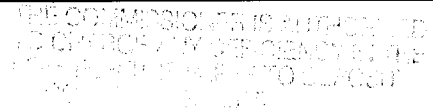
Signature

November 1, 2005
Date

Total number of pages including cover sheet: 3

OMB No. 0651-0011 (exp. 4/94)

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11/03/2005 RMEBRAHT 00000023 11262770

04 FC:8021

40.00 DP

PATENT

REF: 017172 FRAME: 0777

11-01-05

ASSIGNMENT

In consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration paid to each of the undersigned

Insert Name(s)
of Inventor(s)

Kazuma SEKIYA and Takashi ONO

the undersigned hereby sell(s) and assign(s) to

DISCO CORPORATON

Insert Name(s)
of Assignee(s)
Address

of 13-11, Omori-Kita 2-chome, Ota-ku, Tokyo, 143-8580 Japan
(hereinafter designated as the Assignee) the entire right, title and interest for the United States as

defined in 35 USC 100, in the invention known as

Title of
Invention

WAFER PROCESSING METHOD

for which an application for patent in the United States has been executed by the undersigned

Date of Signing
of Application

on October 24, 2005

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division or reissue thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such interference.

The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.


The undersigned hereby authorize(s) and request(s) the Commissioner of Patents to issue any and all Letters Patents of the United States resulting from said application or any division or divisions or continuing or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

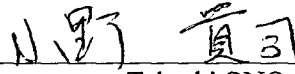
The undersigned hereby grant(s) the firm of WENDEROTH, LIND & PONACK, L.L.P., 2033 K Street, N.W., Suite 800, Washington, D.C. 20006-1021, the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent Office for recordation of this document.

PATENT

REEL: 017172 FRAME: 0778

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

Date October 24, 2005, Name of the Inventor 
Kazuma SEKIYA

Date October 24, 2005, Name of the Inventor 
Takashi ONO

Date _____, Name of the Inventor _____

Date _____, Name of the Inventor _____

Date _____, Name of the Inventor _____

(This assignment should preferably be acknowledged before a United States Consul. If not, then the execution by the Inventor(s) should be witnessed by at least two witnesses who sign here.)

Witness Hiroshi Kitamura

Witness Masatoshi Nanjo